

Advanced Engineering by Thermaltake

P/N : CL-P0326

Application for Intel LGA775 130W Solution



Back Plate



9025 circle fan



Spring screw



Al extrusion with Cu core

SPECIFICATION

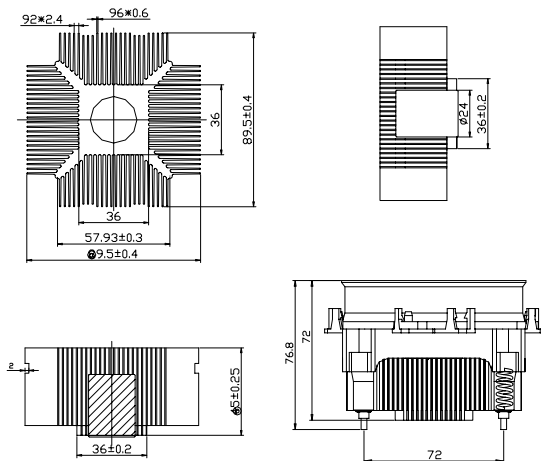


Fan Dimension : $\varnothing 90 \times 90 \times 25$ mm
 Heat Sink Dimension : $89.5 \times 89.5 \times 45$ mm
 Rated Voltage : 12V
 Rated Current : 0.03 AMP
 Fan Speed : 4200RPM
 Air Flow : 71.79CFM (Duty cycle at 100%)
 Static Pressure: 7.23 mm H₂O (Duty cycle at 100%)
 Max. Noise : 44 dB (Duty cycle at 100%)
 Bearing Type : 1 Ball 1 Sleeve Bearing
 Life Expectation : 40,000 hrs in 25
 Connector : 4Pin PWM
 Thermal Interface: TIC-1000A
 Weight: 540g
 Thermal Resistance: $R=0.31$ /W

FEATURES:

- Application for Intel LGA775 130W Solution.
- Aluminum extrusion with Copper core inserted.
- The fourth fan pin has PWM (Pulse Width Modulation) an speed control function: decrease energy consumption, reduces acoustics noise and increase fan performance.
- Plastic back plate & spring screw.
- TIC-1000A interface material perform well.

DIMENSION



Unit: mm

THERMAL PERFORMANCE

